



**American Opto Plus LED Corp.**  
**Case Mold Type LED Display**  
**A2301W G/W**  
**C2301W G/W**

● **EDIT HISTORY**

Version A: Nov. 28, 2012

Preliminary Spec.

Manufacture	Examination	Approving



# American Opto Plus LED Corp.

## Case Mold Type LED Display

### A2301W G/W C2301W G/W

#### ● FEATURES

- 2.30 inch (56.80 mm) Digit Height.
- Low current operation..
- Case mold type.
- Gray face, White segment.
- RoHS compliant, Pb Free.

#### ● DESCRIPTION

The A2301W G/W C2301W G/W is a 2.30 inch (56.80 mm) height single 7-segment display. This device utilizes Super Bright White SMD LED chip which are made from InGaN on a transparent GaN substrate. The display has Gray face, White segment.

#### ● DEVICE

PART NO	DESCRIPTION
Super Bright White	
A2301W G/W	Common Anode
C2301W G/W	Common Cathode

#### RoHS Compliance



#### Pb free.



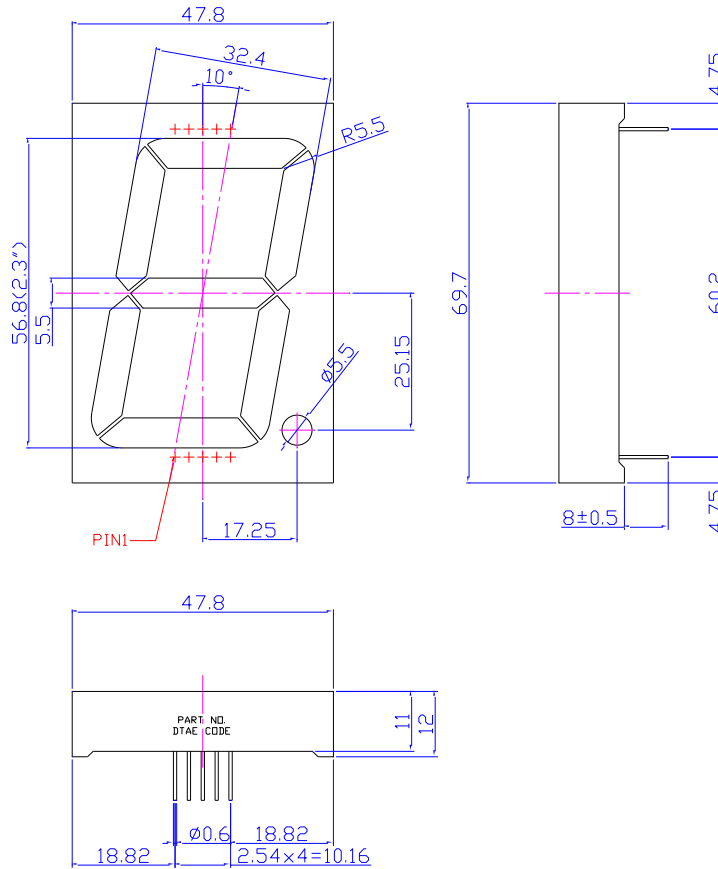


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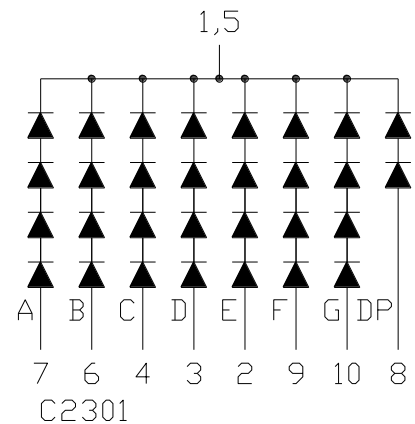
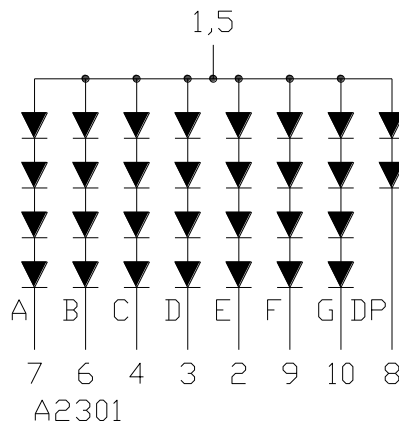
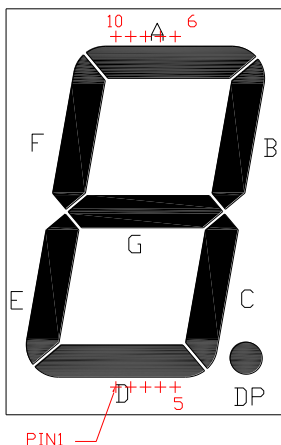
### A2301W G/W C2301W G/W

### ● MECHANICAL DIMENSIONS



NOTES: All dimensions are in millimeters. Tolerances are  $\pm 0.25$  mm unless otherwise noted.

### ● TYPICAL INTERNAL EQUIVALENT CIRCUIT





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● **W: SUPER BRIGHT WHITE (InGaN/GaN)**

ABSOLUTE MAXIMUM RATING AT Ta=25°C

Parameter	Symbol	Super Bright White	Unit
Power dissipation per dice	P <sub>AD</sub>	120	mW
Derating Liner from 25°C per dice	-	0.3	mA/°C
Continuous forward current per dice	I <sub>AF</sub>	30	mA
Peak current per dice (duty cycle 1/10, 1kHz)	I <sub>PF</sub>	100	mA
Reverse voltage per dice	V <sub>R</sub>	5	V
Operating temperature	T <sub>OPR</sub>	-25 to +85	°C
Storage temperature	T <sub>STG</sub>	-25 to +85	°C

ELECTRICAL - OPTICAL CHARACTERISTICS AT Ta=25°C

Characteristic	Symbol	Condition	Min.	Typ.	Max.	Unit	
Forward voltage per Segment (DP)	V <sub>F</sub>	I <sub>F</sub> =20mA	-	12.0 (6.0)	14.4 (7.2)	V	
Reverse Current	I <sub>R</sub>	V <sub>R</sub> =8V	-	-	10	μA	
Peak Wavelength	λ <sub>P</sub>	I <sub>F</sub> =20mA	X	-	0.29	-	nm
			Y	-	0.29	-	
Average Luminous Intensity	I <sub>V</sub>	I <sub>F</sub> =10mA	76	160	-	mcd	
Spectrum Radiation Bandwidth	Δλ	I <sub>F</sub> =20mA	-	30	-	nm	



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### A2301W G/W C2301W G/W

#### ● W: SUPER BRIGHT WHITE (InGaN/GaN) CURVE

Typical Electro-optical Characteristic Curves  
(25 °C Free Air Temperature Unless Otherwise Specified)

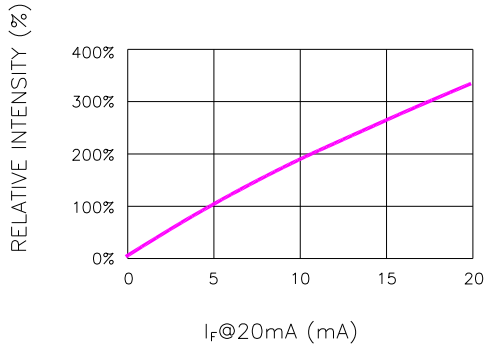


Fig.1 RELATIVE INTENSITY VS. FORWARD CURRENT

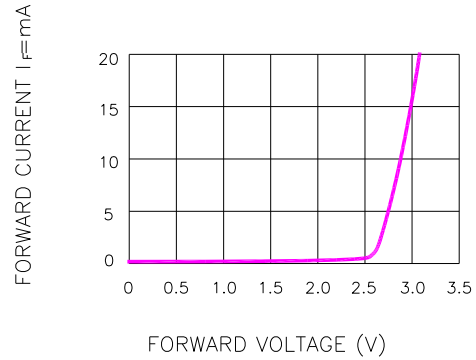


Fig.2 FORWARD CURRENT VS. FORWARD VOLTAGE

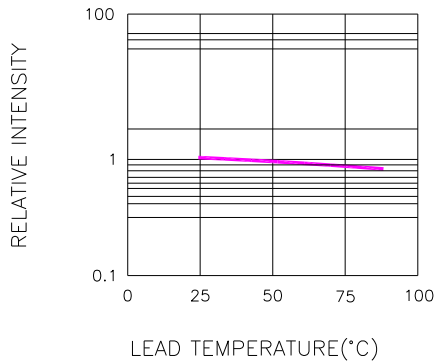


Fig.3 RELATIVE INTENSITY VS. LEAD TEMPERATURE  
(PULSED 20 mA; 300us PULSE, 10ms PERIOD)

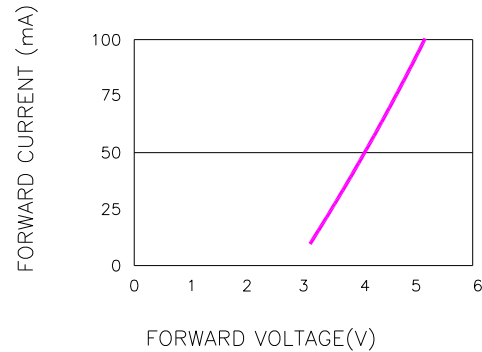


Fig.4 PEAK FORWARD VOLTAGE VS. FORWARD CURRENT  
(100us TEST PULSE, 1% DUTY CYCLE)

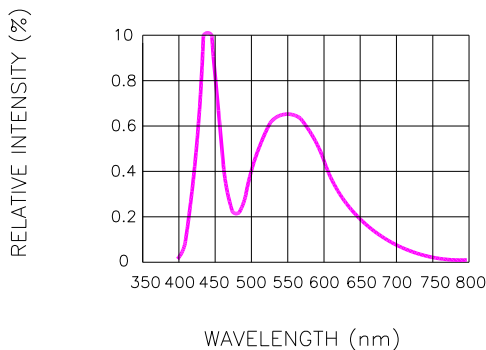


Fig.4 RELATIVE INTENSITY VS. WAVELENGTH

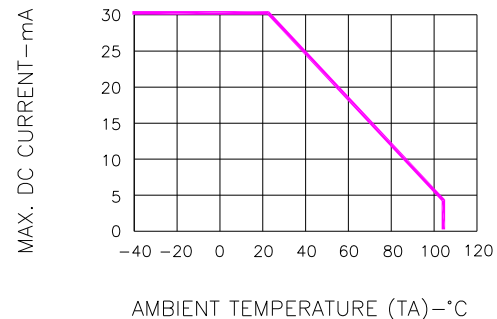


Fig.7 MAX. ALLOWABLE DC CURRENT VS. AMBIENT TEMPERATURE



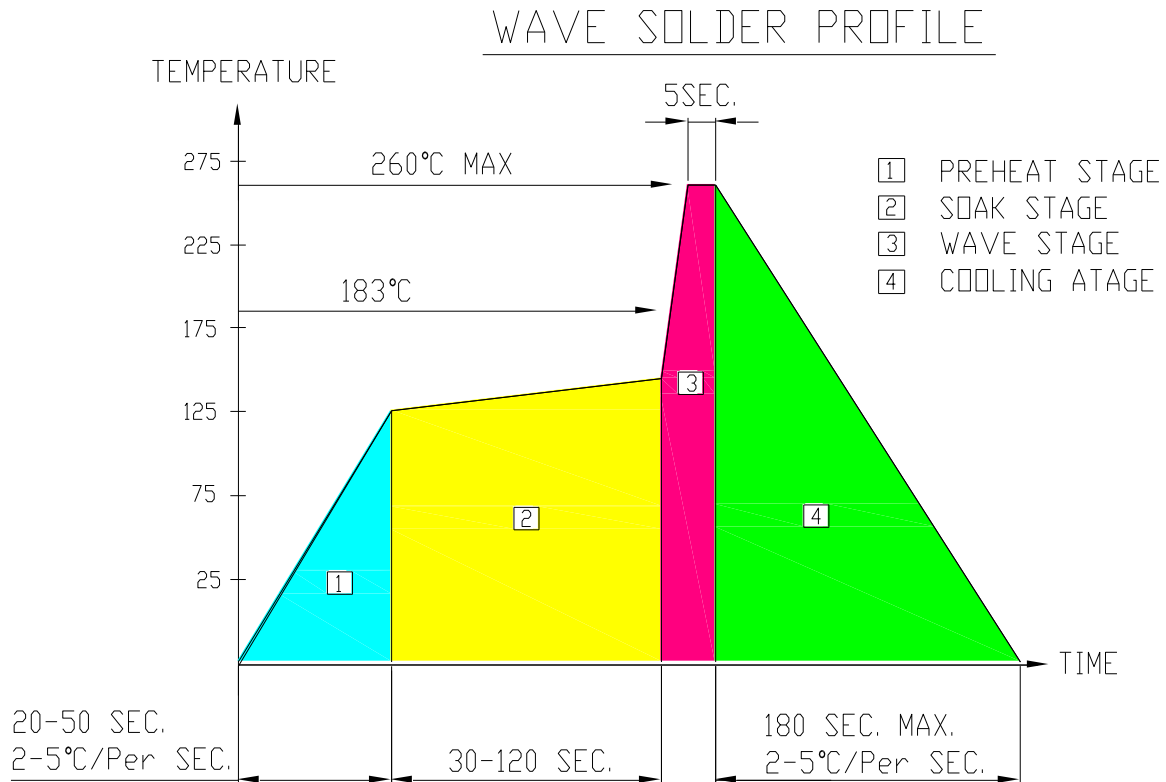
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## ● RECOMMEND SOLDERING PROFILE



## ● SOLDERING IRON

Basic spec is  $\leq 4$  sec when 260°C. If temperature is higher, time should be shorter (+10°C → 1 sec). Power dissipation of Iron should be smaller than 15W, and temperature should be controllable. Surface temperature of the device should be under 230°C.

## ● REWORK

Customer must finish rework within  $\leq 4$  sec under 245°C.